

- Install adhesive feet per assembly variant Z28
  - Mount UI to align with pin 1 of pattern Z25
  - Install shunts on referenced headers after final board wash Z27
  - Install P1 and P2 on mating headers after final board wash Z26
  - These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified. Z24
  - These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable. Z23
  - These assemblies are ESD sensitive, ESD precautions shall be observed. Z22
- Z21 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.

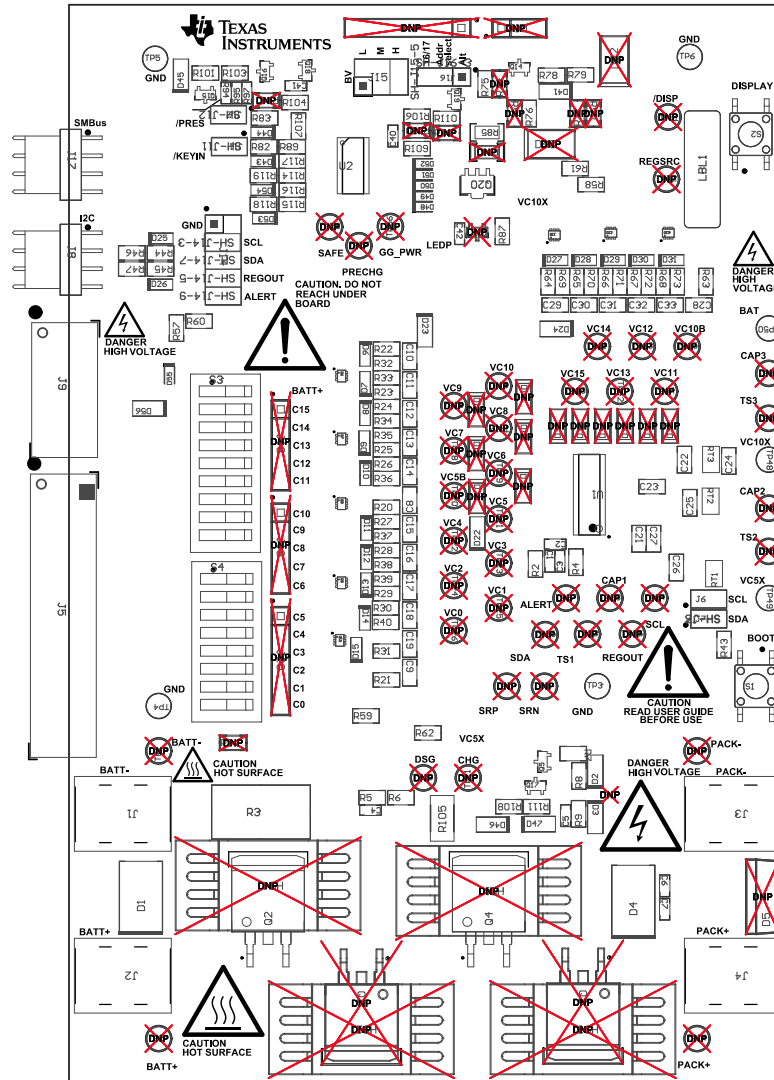
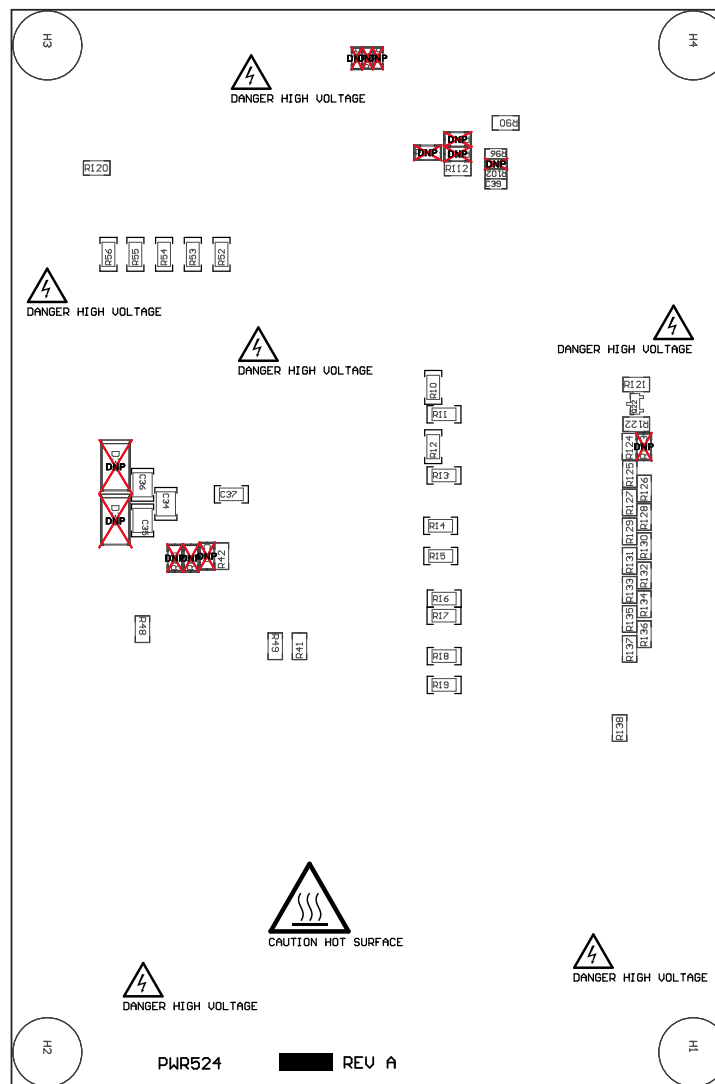


TABLE 1	
Variant	Label text
-001	BQ76940EVM
-002	BQ76930EVM

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED, AND MAY NOT BE IN BILL OF MATERIALS  
 ASSEMBLY VARIANT: -001

PCB VIEWED FROM TOP SIDE	BOARD #: PWR524	REV: A	SUN REV: Not In VersionControl
IGNORE -> Top Overlay			
PLOT NAME = Top Assembly Drawing	GENERATED : 2/22/2014 8:50:15 PM	TEXAS INSTRUMENTS	



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED, AND MAY NOT BE IN BILL OF MATERIALS  
 ASSEMBLY VARIANT: -001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PWR524	REV: A	SUN REV: Not In VersionControl
	IGNORE -> Bottom Overlap		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 2/22/2014 8:50:17 PM	TEXAS INSTRUMENTS	

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